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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/562,630	12/23/2005	Kyouhiro Yoshida	20057-002US1 PCT-2004-008	8597
26211 7590 02/13/2009 FISH & RICHARDSON P.C. P.O. BOX 1022 MINNEAPOLIS, MN 55440-1022			EXAMINER CHEN, XIAOLIANG	
			ART UNIT 2841	PAPER NUMBER
			NOTIFICATION DATE 02/13/2009	DELIVERY MODE ELECTRONIC

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

PATDOCTC@fr.com

Office Action Summary	Application No. 10/562,630	Applicant(s) YOSHIDA, KYOUIHIRO	
	Examiner XIAOLIANG CHEN	Art Unit 2841	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 21 January 2009.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-6 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-6 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08)
Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 01-29-09 has been entered.

Response to Arguments

2. Applicant's arguments with respect to claim 1 have been considered but are moot in view of the new ground(s) of rejection.

Claim Rejections - 35 USC § 103

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

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4. Claims 1, 2 and 4-6 are rejected under 35 U.S.C. 103(a) as being unpatentable over Maruyama et al. (US20040208211) in view of Chien-Hung et al. (US20030001250) and Smith (US5998733).

Re claim 1, Maruyama et al. show and disclose

A communication module comprising:

a semiconductor member (7, fig. 1B);

a printed circuit board (3, fig. 1B) on which said semiconductor member is mounted and to which said semiconductor member is electrically connected (fig. 1B);

a stem (1, fig. 1C) through which said board is inserted and to which said board is fixed,

a cap (11, fig. 1C) so disposed as to cover said semiconductor member.

a fixing material (a glass material 64 fixed to the stem hole [0004], for a hermetically sealed structure [0002]),

Maruyama et al. does not disclose

1) the printed circuit board being the flexible printed circuit board, having an insulative cover comprising polyimide resin, wherein the insulative cover is fixed to the stem with a fixing material,

2) the fixing material having a melting point in a range of 300 to 350°C;

Chien-Hung et al. teaches a device wherein

1) the printed circuit board being a flexible printed circuit board (a flexible printed circuit board [Abstract]), having an insulative cover (110, fig. 1)

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comprising polyimide resin (110 is made from a tape with a polyimide flexible material [0023], Note: a flexible printed circuit board made from a polyimide resin is well known in the art, see cited references US20020109074 and US6664479), wherein the insulative cover is fixed to the stem with the fixing material (132, fig. 1, adhesive compound 132 like thermal melting compound formed on the surface of flexible circuit board [0023]),

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to use a flexible printed circuit board with a cover and sealed bonding to the stem as taught by Chien-Hung et al. in the electronic device of Maruyama et al., in order to bond the circuit board in different direction with any degrees of angle and easily connect the circuit board by any orientation other than straight in the device.

Smith teaches a device wherein

2) the fixing material (a hermetic glass-to-composite seal [Abstract]) having a melting point in a range of 300 to 350°C (The vitreous solder glass preferably exhibits a melting temperature in the range of about 300 to about 500 degrees C. [Abstract]);

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to use the glass with low melting point as taught by Smith in the electronic device of Maruyama et al., in order to fix the flexible circuit board to the stem without damage to the flexible circuit board.

Re claim 2, Maruyama et al. show and disclose

The communication module according to Claim 1, wherein the semiconductor member is at least one of a light emitting element (6, fig. 1C), a light receiving element (8) and an integrated circuit (33, fig. 3C).

Re claim 4, Maruyama et al. show and disclose

The communication module according to Claim 1,
wherein a plurality of different flexible printed circuit boards (different wiring boards and layers in fig. 2 also could use the flexible printed circuit boards as in claim 1) are fixed to the stem.

Re claim 5, Maruyama et al. show and disclose

The communication module according to Claim 1, wherein an end of the flexible printed circuit board that protrudes from the stem has a connector (113, fig. 21B) that can connect to a subsequent-stage circuit board (400, fig. 22A).

Re claim 6, Maruyama et al. show and disclose

The communication module according to Claim 1, wherein the flexible printed circuit board exhibits a bent-shape (the flexible substrate 400 is previously bent in the trapezoidal shape for use [0108]) when in a plane.

5. Claim 3 is rejected under 35 U.S.C. 103(a) as being unpatentable over Maruyama et al. in view of Chien-Hung et al. and Smith (US5998733), as applied to claim 1 above, further in view of Uchida (US20020109074)

Re claim 3, Maruyama et al., Chien-Hung et al. and Smith disclose

The communication module according to Claim 1,
Maruyama et al. Chien-Hung et al. and Smith do not disclose

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the flexible printed circuit board including a type of lines selected from among coplanar lines, micro-strip lines, and grounded coplanar lines.

Uchida teaches a device wherein

the flexible printed circuit board includes a type of lines selected from among coplanar lines, micro-strip lines, and grounded coplanar lines (micro strip line [0336]).

Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to use the flexible printed circuit board with the micro strip line as taught by Uchida in the electronic device of Maruyama et al., in order to increase the mounting area and provide EMI-free optical wiring of the flexible printed circuit board. (Uchida, paragraph [0337])

Conclusion

6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

US 20010024461 US 20020074157 US 20030001250 US 7080445.

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

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the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to XIAOLIANG CHEN whose telephone number is (571)272-9079. The examiner can normally be reached on 7:00-5:00 (EST), Monday-Thursday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Dean Reichard can be reached on 571-272-2800, ext 31. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Dean A. Reichard/
Supervisory Patent Examiner, Art Unit 2841

Xiaoliang Chen
Examiner
Art Unit 2841